

General Description

The MAX6895-MAX6898 is a family of small, low-power, voltage-monitoring circuits with sequencing capability. These miniature devices offer tremendous flexibility with an adjustable threshold capable of monitoring down to 0.5V and an external capacitor-adjustable time delay. These devices are ideal for use in power-supply sequencing, reset sequencing, and power-switching applications. Multiple devices can be cascaded for complex sequencing applications.

A high-impedance input with a 0.5V threshold allows an external resistive divider to set the monitored threshold. The output asserts (OUT = high or \overline{OUT} = low) when the input voltage rises above the 0.5V threshold and the enable input is asserted (ENABLE = high or ENABLE = low). When the voltage at the input falls below 0.5V or when the enable input is deasserted (ENABLE = low or ENABLE = high), the output deasserts (OUT = low or OUT = high). All devices provide a capacitor-programmable delay time from when the input rises above 0.5V to when the output is asserted. The MAX689_A versions provide the same capacitor-adjustable delay from when enable is asserted to when the output asserts. The MAX689_P devices have a 1µs propagation delay from when enable is asserted to when the output asserts.

The MAX6895A/P offers an active-high enable input and an active-high push-pull output. The MAX6896A/P offers an active-low enable input and an active-low push-pull output. The MAX6897A/P offers an activehigh enable input and an active-high open-drain output. Finally, the MAX6898A/P offers an active-low enable input and an active-low open-drain output.

All devices operate from a 1.5V to 5.5V supply voltage and are fully specified over the 0°C to +125°C operating temperature range. Each device is available in an ultra-small 6-pin µDFN (1.0mm x 1.5mm) package.

Applications

Automotive Computers/Servers Critical µP Monitoring Medical Equipment Intelligent Instruments Set-Top Boxes Portable Equipment Telecom

Typical Operating Circuit and Selector Guide appear at end of data sheet.

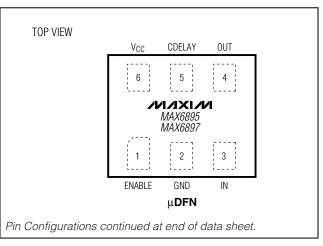
Features

- ♦ 1.75% Accurate Adjustable Threshold Over **Temperature**
- ♦ Operate from Vcc of 1.5V to 5.5V
- ♦ Capacitor-Adjustable Delay
- ◆ Active-High/-Low Enable Input Options
- **♦ Active-High/-Low Output Options**
- ♦ Open-Drain (28V Tolerant)/Push-Pull Output **Options**
- **♦** Low Supply Current (10µA, typ)
- ◆ Fully Specified from 0°C to +125°C
- ♦ Ultra-Small 6-Pin µDFN Package (1.5mm x 1.0mm x 0.8mm)

Ordering Information

PART	TEMP RANGE	PIN- PACKAGE	TOP MARK
MAX6895AALT-T	0°C to +125°C	6 µDFN-6	AW
MAX6895PALT-T	0°C to +125°C	6 µDFN-6	AX
MAX6896AALT-T	0°C to +125°C	6 µDFN-6	AY
MAX6896PALT-T	0°C to +125°C	6 µDFN-6	AZ
MAX6897AALT-T	0°C to +125°C	6 µDFN-6	ВА
MAX6897PALT-T	0°C to +125°C	6 µDFN-6	BB
MAX6898AALT-T	0°C to +125°C	6 µDFN-6	BD
MAX6898PALT-T	0°C to +125°C	6 µDFN-6	ВС

Pin Configurations



MIXIM

Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

V_{CC} , ENABLE, \overline{ENABLE} , IN0.3V to +6V OUT, \overline{OUT} (push-pull)0.3V to (V_{CC} + 0.3V) OUT, \overline{OUT} (open-drain)0.3V to +30V CDELAY0.3V to (V_{CC} + 0.3V) Output Current (all pins)	Storage Temperature Range65°C to +150°C Junction Temperature+150°C Lead Temperature (soldering, 10s)+300°C
6-Pin µDFN (derate 2.1mW/°C above +70°C)167.7mW	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

($V_{CC} = 1.5V$ to 5.5V, $T_A = 0$ °C to +125°C, unless otherwise specified. Typical values are at $V_{CC} = 3.3V$ and $T_A = +25$ °C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SUPPLY	•	·	•			
Operating Voltage Range	Vcc		1.5		5.5	V
Undervoltage Lockout (Note 2)	UVLO	V _{CC} falling	1.20		1.35	V
V _{CC} Supply Current	Icc	V _{CC} = 3.3V, no load		10	20	μΑ
IN						
Threshold Voltage	V _T H	V _{IN} rising, 1.5V < V _{CC} < 5.5V	0.491	0.5	0.509	V
Hysteresis	V _H YST	V _{IN} falling		5		mV
Input Current (Note 3)	I _{IN}	V _{IN} = 0V or V _{CC}	-15		+15	nA
CDELAY						
Delay Charge Current	ICD		200	250	300	nA
Delay Threshold	V _{TCD}	CDELAY rising	0.95	1.00	1.05	V
CDELAY Pulldown Resistance	RCDELAY			130	500	Ω
ENABLE/ENABLE						
Input Low Voltage	V _{IL}				0.4	V
Input High Voltage	VIH		1.4	•	•	V
Input Leakage Current	ILEAK	ENABLE, ENABLE = V _{CC} or GND	-100	•	+100	nA

ELECTRICAL CHARACTERISTICS (continued)

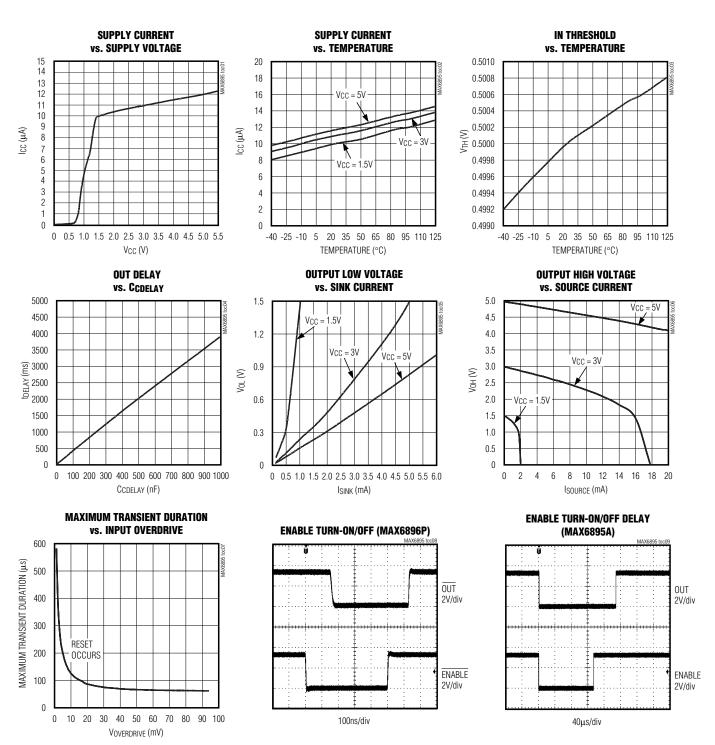
 $(V_{CC} = 1.5V \text{ to } 5.5V, T_A = 0^{\circ}\text{C} \text{ to } +125^{\circ}\text{C}, \text{ unless otherwise specified.}$ Typical values are at $V_{CC} = 3.3V$ and $T_A = +25^{\circ}\text{C}, \text{ unless otherwise noted.})$ (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
OUT/OUT								
Output Low Voltage (Open-Drain	Voi	$V_{CC} \ge 1.2V$, $I_{SINK} = 90\mu A$, MAX6895/MAX6897 only				0.3	V	
or Push-Pull)	Vol	$V_{CC} \ge 2.25V$,	I _{SINK} = 0.	5mA			0.3	V
		V _{CC} ≥ 4.5V, I _S	SINK = 1m	A			0.4	
Output High Voltage (Push-Pull)	Voh	V _{CC} ≥ 2.25V, I _{SOURCE} = 500μA		0.8 x V _{CC}				
Output riigii voitage (i usii-i uii)	VOH	V _{CC} ≥ 4.5V, I _{SOURCE} = 800μA		800μΑ	0.8 x V _{CC}			- V
Output Open-Drain Leakage Current	I _{LKG}	Output high ir	npedance	e, V _{OUT} = 28V			1	μΑ
TIMING								
IN to OUT/OUT Propagation	tDELAY	V _{IN} rising	CCDELA'	y = 0		40		μs
Delay	UELAT	$C_{CDELAY} = 0.047 \mu F$			190		ms	
	t_{DL}	V _{IN} falling			16		μs	
Startup Delay (Note 4)						2		ms
ENABLE/ENABLE Minimum Input Pulse Width	tpw			1			μs	
ENABLE/ENABLE Glitch Rejection					100		ns	
ENABLE/ENABLE to OUT/OUT Delay	tOFF	From device enabled to device disabled			150		ns	
	tpropp	From device disabled to device enabled (P version)			150		ns	
ENABLE/ENABLE to OUT/OUT Delay		From device disabled to device enabled (A version)	disabled	CCDELAY = 0		20		μs
Boldy	tpropa		CCDELAY = 0.047µF		190		ms	

- Note 1: All devices are production tested at $T_A = +25^{\circ}C$. Limits over temperature are guaranteed by design.
- Note 2: When V_{CC} falls below the UVLO threshold, the outputs will deassert (OUT goes low, \overline{OUT} goes high). When V_{CC} falls below 1.2V, the output state cannot be determined.
- Note 3: Guaranteed by design.
- Note 4: During the initial power-up, V_{CC} must exceed 1.5V for at least 2ms before the output is guaranteed to be in the correct state.

Typical Operating Characteristics

($V_{CC} = 3.3V$ and $T_A = +25^{\circ}C$, unless otherwise noted.)



Pin Description

PIN					
MAX6895/ MAX6897	MAX6896/ MAX6898	NAME	FUNCTION		
1	_	ENABLE	Active-High Logic-Enable Input. Drive ENABLE low to immediately deassert the output to its false state (OUT = low or $\overline{\text{OUT}}$ = high) independent of V _{IN} . With V _{IN} above V _{TH} , drive ENABLE high to assert the output to its true state (OUT = high or $\overline{\text{OUT}}$ = low) after the adjustable delay period (MAX689_A) or a 150ns propagation delay (MAX689_P).		
_	1	ENABLE	Active-Low Logic-Enable Input. Drive $\overline{\text{ENABLE}}$ high to immediately deassert the output to its false state (OUT = low or $\overline{\text{OUT}}$ = high) independent of V_{IN} . With V_{IN} above V_{TH} , drive $\overline{\text{ENABLE}}$ low to assert the output to its true state (OUT = high or $\overline{\text{OUT}}$ = low) after the adjustable delay period (MAX689_A) or a 150ns propagation delay (MAX689_P).		
2	2	GND	Ground		
3	3	IN	High-Impedance Monitor Input. Connect IN to an external resistive divider to set the desired monitored threshold. The output changes state when V_{IN} rises above 0.5V and when V_{IN} falls below 0.495V.		
4	_	OUT	Active-High Sequencer/Monitor Output, Push-Pull (MAX6895) or Open-Drain (MAX6897). OUT is asserted to its true state (OUT = high) when V_{IN} is above V_{TH} and the enable input is in its true state (ENABLE = high or \overline{ENABLE} = low) for the capacitor-adjusted delay period. OUT is deasserted to its false state (OUT = low) immediately after V_{IN} drops below V_{TH} - 5mV or the enable input is in its false state (ENABLE = low or \overline{ENABLE} = high). The open-drain version requires an external pullup resistor.		
_	4	OUT	Active-Low Sequencer/Monitor Output, Push-Pull (MAX6896) or Open-Drain (MAX6898). OUT is asserted to its true state (\overline{OUT} = low) when V _{IN} is above V _{TH} and the enable input is in its true state (ENABLE = high or \overline{ENABLE} = low) for the CDELAY adjusted timeout period. OUT is deasserted to its false state (\overline{OUT} = high) immediately after V _{IN} drops below V _{TH} - 5mV or the enable input is in its false state (ENABLE = low or \overline{ENABLE} = high). The open-drain version requires an external pullup resistor.		
5	5	CDELAY	Capacitor-Adjustable Delay. Connect an external capacitor (C_{CDELAY}) from CDELAY to GND to set the IN to OUT (and ENABLE to OUT or ENABLE to OUT for A version devices) delay period. $t_{DELAY} = (C_{CDELAY} \times 4.0 \times 10^6) + 40 \mu s$. There is a fixed short delay ($40 \mu s$, typ) for the output deasserting when V_{IN} falls below V_{TH} .		
6	6	Vcc	Supply Voltage Input. Connect a 1.5V to 5.5V supply to V _{CC} to power the device. For noisy systems, bypass with a 0.1µF ceramic capacitor to GND.		

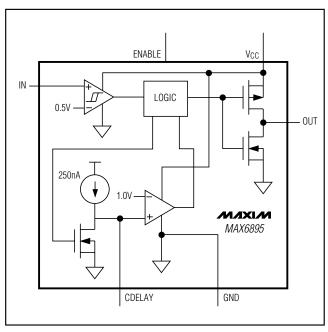


Figure 1. MAX6895 Functional Diagram

Detailed Description

The MAX6895–MAX6898 is a family of ultra-small, low-power, sequencing/supervisory circuits. These devices provide adjustable voltage monitoring for inputs down to 0.5V. They are ideal for use in power-supply sequencing, reset sequencing, and power-switching applications. Multiple devices can be cascaded for complex sequencing applications.

Voltage monitoring is performed through a high-impedance input (IN) with an internally fixed 0.5V threshold. When the voltage at IN falls below 0.5V or when the enable input is deasserted (ENABLE = low or ENABLE = high), the output deasserts (OUT goes low or OUT goes high). When V_{IN} rises above 0.5V and the enable input is asserted (ENABLE = high or ENABLE = low), the output asserts (OUT goes high or OUT goes low) after a capacitor-programmable time delay.

With $V_{\rm IN}$ above 0.5V, the enable input can be used to turn the output on or off. After the enable input is asserted, the output turns on with a capacitor-programmable delay period (A version) or with a 150ns propagation delay (P version). Tables 1 and 2 detail the output state depending on the various input and enable conditions.

Table 1. MAX6895/MAX6897 Output

IN ENABLE		OUT
V _{IN} < V _{TH}	Low	Low
V _{IN} < V _{TH}	High	Low
V _{IN} > V _{TH}	Low	Low
		OUT = V _{CC} (MAX6895)
V _{IN} > V _{TH}	High	OUT = high impedance (MAX6897)

Table 2. MAX6896/MAX6898 Output

IN	ENABLE	OUT		
		$\overline{OUT} = V_{CC} (MAX6896)$		
V _{IN} < V _{TH}	Low	OUT = high impedance (MAX6898)		
	High	OUT = V _{CC} (MAX6896)		
V _{IN} < V _{TH}		OUT = high impedance (MAX6898)		
V _{IN} > V _{TH}	Low	Low		
V _{IN} > V _{TH}	High	$\overline{OUT} = V_{CC} (MAX6896)$		
		OUT = high impedance (MAX6898)		

Supply Input (Vcc)

The device operates with a V_{CC} supply voltage from 1.5V to 5.5V. To maintain a 1.75% accurate threshold, V_{CC} must be above 1.5V. When V_{CC} falls below the UVLO threshold, the output deasserts. When V_{CC} falls below 1.2V the output state cannot be determined. For noisy systems, connect a 0.1µF ceramic capacitor from V_{CC} to GND. For the push-pull active-high output option, a 100k Ω external pulldown resistor to ground ensures the correct logic state for V_{CC} down to 0.

Monitor Input (IN)

Connect the center point of a resistive divider to IN to monitor external voltages (see R1 and R2 of the *Typical Operating Circuit*). IN has a rising threshold of $V_{TH} = 0.5V$ and a falling threshold of 0.495V (5mV hysteresis). When V_{IN} rises above V_{TH} and ENABLE is high (or ENABLE is low) OUT goes high (\overline{OUT} goes low) after the programmed t_{DELAY} period. When V_{IN} falls below 0.495V, OUT goes low (\overline{OUT} goes high) after a 16 μ s delay. IN has a maximum input current of 15nA so large-value resistors are permitted without adding significant error to the resistive divider.

Adjustable Delay (CDELAY)

When V_{IN} rises above V_{TH} with ENABLE high ($\overline{\text{ENABLE}}$ low), the internal 250nA current source begins charging an external capacitor connected from CDELAY to GND. When the voltage at CDELAY reaches 1V, the output asserts (OUT goes high or $\overline{\text{OUT}}$ goes low). When the output asserts, CCDELAY is immediately discharged. Adjust the delay ($\overline{\text{tDELAY}}$) from when V_{IN} rises above V_{TH} (with ENABLE high or $\overline{\text{ENABLE}}$ low) to OUT going high ($\overline{\text{OUT}}$ going low) according to the equation:

 $tDELAY = CCDELAY \times 4.0 \times 10^{-6} + 40\mu s$

where $C_{\mbox{\scriptsize CDELAY}}$ is the external capacitor from CDELAY to GND.

For adjustable delay devices (A version), when $V_{\text{IN}} > 0.5V$ and ENABLE goes from low to high (ENABLE goes from high to low) the output asserts after a tDELAY period. For nonadjustable delay devices (P version) there is a 1µs propagation delay from when the enable input is asserted to when the output asserts. Figures 2 through 5 show the timing diagrams for the adjustable and fixed delay versions, respectively.

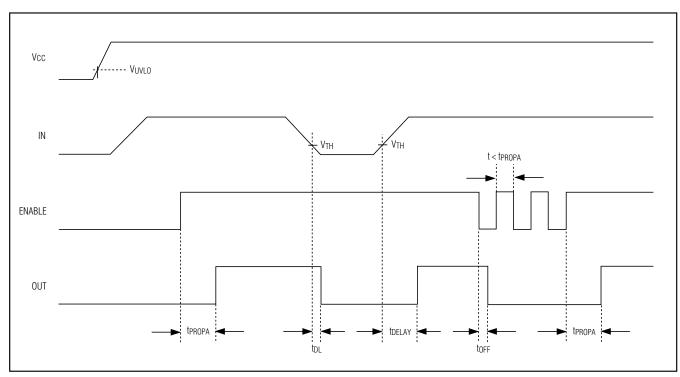


Figure 2. MAX6895A/MAX6897A Timing Diagram

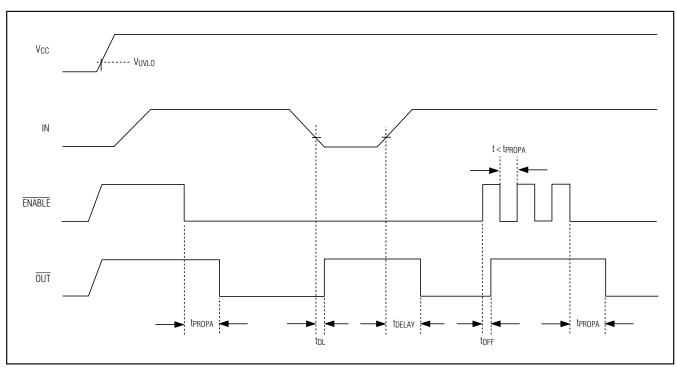


Figure 3. MAX6896A/MAX6898A Timing Diagram

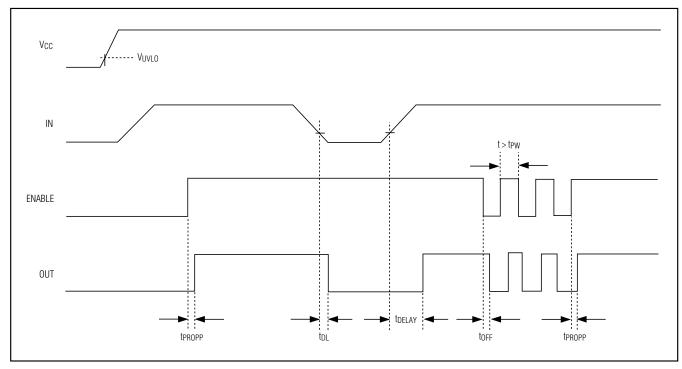


Figure 4. MAX6895P/MAX6897P Timing Diagram

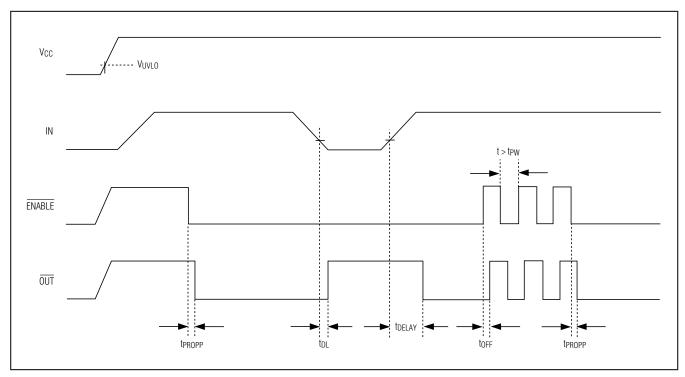


Figure 5. MAX6896P/MAX6898P Timing Diagram

Enable Input (ENABLE or ENABLE)

The MAX6895/MAX6897 offer an active-high enable input (ENABLE), while the MAX6896/MAX6898 offer an active-low enable input (ENABLE). With V_{IN} above V_{TH}, drive ENABLE high (ENABLE low) to force OUT high (OUT low) after the adjustable delay time (A versions). For P version devices, when V_{IN} > 0.5V and enable is asserted, the output asserts after typically 150ns.

The enable input has logic-high and logic-low voltage thresholds of 1.4V and 0.4V, respectively. For both versions, when $V_{\text{IN}} > 0.5 \text{V}$, drive ENABLE low (ENABLE high) to force OUT low (OUT high) within 150ns typ.

Output (OUT or OUT)

The MAX6895 offers an active-high, push-pull output (OUT), and the MAX6896 offers an active-low push-pull output $(\overline{\text{OUT}})$. The MAX6897 offers an active-high open-drain output (OUT), and the MAX6898 offers an active-low open-drain output $(\overline{\text{OUT}})$.

Push-pull output devices are referenced to V_{CC} . Open-drain outputs can be pulled up to 28V.

Applications Information

Input Threshold

The MAX6895–MAX6898 monitor the voltage on IN with an external resistive divider (see R1 and R2 in the *Typical Operating Circuit*). R1 and R2 can have very high values to minimize current consumption due to low IN leakage currents (± 15 nA max). Set R2 to some conveniently high value (1M Ω , for example) and calculate R1 based on the desired monitored voltage using the following formula:

$$R1 = R2 \times \left[\frac{V_{MONITOR}}{V_{IN}} - 1 \right]$$

where $V_{MONITOR}$ is the desired monitored voltage and V_{IN} is the detector input threshold (0.5V).

Pullup Resistor Values (MAX6897/MAX6898)

The exact value of the pullup resistors for the opendrain outputs is not critical, but some consideration should be made to ensure the proper logic levels when the device is sinking current. For example, if V_{CC} = 2.25V and the pullup voltage is 28V, you would try to keep the sink current less than 0.5mA as shown in the *Electrical Characteristics* table. As a result, the pullup resistor should be greater than $56k\Omega$. For a 12V pullup, the resistor should be larger than $24k\Omega$. It should be noted that the ability to sink current is dependent on the V_{CC} supply voltage.

Typical Application Circuits

Figures 6, 7, 8 show typical applications for the MAX6895–MAX6898. Figure 6 shows the MAX6895

used with a p-channel MOSFET in an overvoltage protection circuit. Figure 7 shows the MAX6895 in a low-voltage sequencing application using an n-channel MOSFET. Figure 8 shows the MAX6895 used in a multiple-output sequencing application.

Using an n-Channel Device for Sequencing

In higher power applications, using an n-channel device reduces the loss across the MOSFETs as it offers a lower drain-to-source on-resistance. However, an n-channel MOSFET requires a sufficient VGS voltage to fully enhance it for a low RDS_ON. The application in Figure 7 shows the MAX6895 in a switch sequencing application using an n-channel MOSFET.

Similarly, if a higher voltage is present in the system, the open-drain version can be used in the same manner.

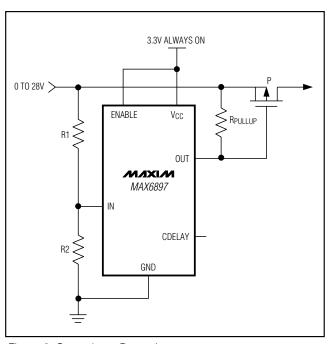


Figure 6. Overvoltage Protection

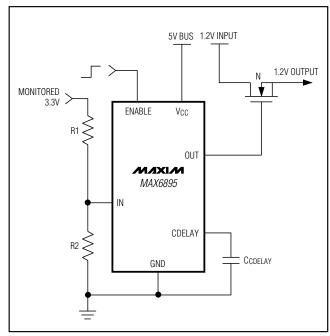


Figure 7. Low-Voltage Sequencing Using an n-Channel MOSFET

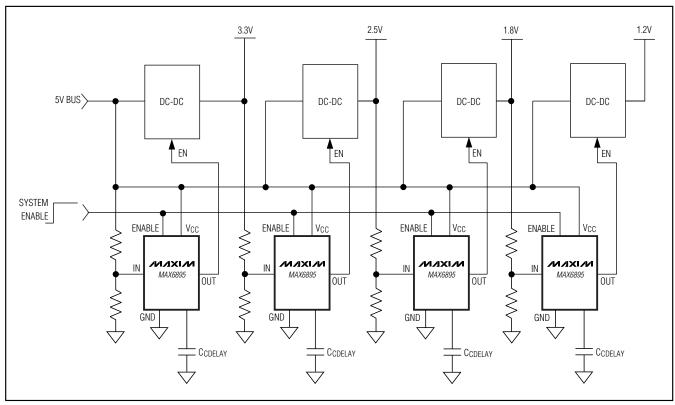


Figure 8. Multiple-Output Sequencing

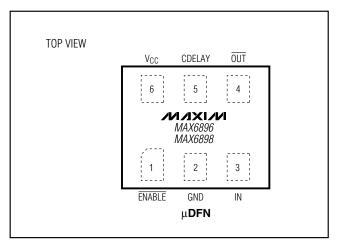
Selector Guide

PART	ENABLE INPUT	OUTPUT	INPUT (IN) DELAY	ENABLE DELAY
MAX6895AALT	Active-High	Active-High, Push-Pull	Capacitor Adjustable	Capacitor Adjustable
MAX6895PALT	Active-High	Active-High, Push-Pull	Capacitor Adjustable	150ns Delay
MAX6896AALT	Active-Low	Active-Low, Push-Pull	Capacitor Adjustable	Capacitor Adjustable
MAX6896PALT	Active-Low	Active-Low, Push-Pull	Capacitor Adjustable	150ns Delay
MAX6897AALT	Active-High	Active-High, Open-Drain	Capacitor Adjustable	Capacitor Adjustable
MAX6897PALT	Active-High	Active-High, Open-Drain	Capacitor Adjustable	150ns Delay
MAX6898AALT	Active-Low	Active-Low, Open-Drain	Capacitor Adjustable	Capacitor Adjustable
MAX6898PALT	Active-Low	Active-Low, Open-Drain	Capacitor Adjustable	150ns Delay

Typical Operating Circuit

1.5V TO 5.5V ENABLE VCC OUT MAXIM MAX6895 IN CDELAY GND CCDELAY

Pin Configurations (continued)

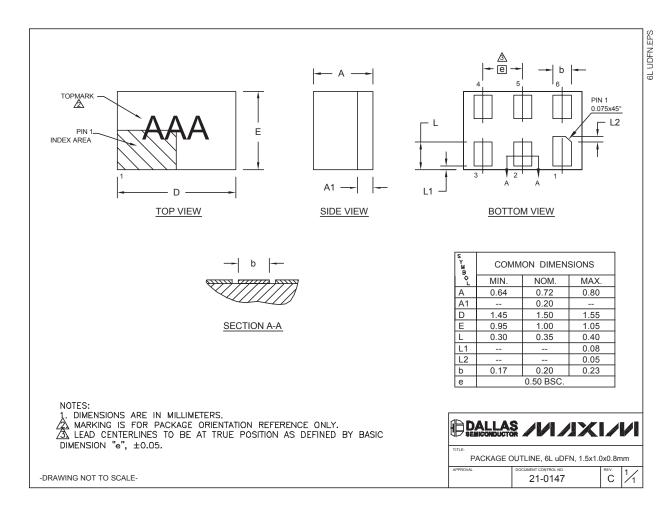


_Chip Information

PROCESS: BICMOS

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)



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